



Resistivity and Surface resistance Measurements of SEMICONDUCTORS and Conductors

Jerzy Krupka Warsaw University of Technology Central Office of Measures, Poland

Outline of presentation

- Introduction
- Basic definitions
- Measurements of bulk semiconductor samples
- Contactless measurements on wafers
- Resistivity measurements with split post and single post dielectric resonators
- Measurements of thin conducting and semiconducting films

Basic definitions

The complex permittivity of an isotropic material in general can be written as:

$$\mathcal{E} = \mathcal{E}_{0}\mathcal{E}_{r} = \mathcal{E}_{0}(\mathcal{E}_{r}^{'} - j\mathcal{E}_{rd}^{''} - j\frac{\sigma}{\omega\mathcal{E}_{0}}) =$$

$$= \mathcal{E}_{0}\mathcal{E}_{r}^{'}(1 - j\tan\delta_{eff})$$

$$\mathcal{E}_{eff}^{''} = \mathcal{E}_{0}(\mathcal{E}_{rd}^{''} + \frac{\sigma}{\omega\mathcal{E}_{0}}) \qquad \tan\delta_{eff} = \tan\delta_{d} + \frac{\sigma}{\omega\mathcal{E}_{0}\mathcal{E}_{r}^{''}}$$

- \mathcal{E}_0 permittivity of vacuum ω angular frequency
 - σ conductivity

 $\tan \delta_d$ - dielectric loss tangent associated with pure dielectric loss mechanisms

Dielectric loss tangent versus frequency for HR semiconductors. Solid line – conductivity term, dotted line (red) – total



microwaves

Measurements of bulk HR semiconductor samples employing dielectric resonator method

Measurement techniques of bulk high resistivity HR samples



Sketches of measurement fixtures used in experiments a) Useful only if $tan\delta < 0.01$ b) $tan\delta > 0.1$

Cryogenic measurement setup - photograph







Persistent photoconductivity in bulk GaAs sample at cryogenic temperatures



Permittivity and the dielectric loss tangent versus temperature for HR silicon at frequency about 4.98 GHz





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Contactless methods for resistivity measurements of semiconductor wafers and thin conducting films

- •Time domain and frequency domain capacitive techniques
- •RF method (eddy currents)
- •Split post dielectric resonators
- •Single post dielectric resonators

Capacitive techniques

1) Time domain

Stibal R, Windscheif J and Jantz W 1991 Semicond. Sci. Technol. 6 995-12001.



Time response for GaP sample having resistivity of $5.5 \times 10^5 \ \Omega \text{cm}$

If Ca >> Cs the time constant does not depend on the size capacitor but only on permittivity and resistivity of material under test $\tau = \mathcal{E}_0 \mathcal{E}_r \rho$

Otherwise $\tau = R(C_{\alpha} + C_{s})$



2) Frequency domain:

D. Siebert, Physik der Kondensierten Materie, 2, 394, 1964

Frequency responses for GaP sample having resistivity of $5.5 \times 10^5 \ \Omega \text{cm}$



Contactless method for measurements of resistivity of semiconductors at RF (Lehighton Inc.)



[1] G. L. Miller, D. A. H. Robinson, and J. D. Wiley, "Contactless measurement of semiconductor conductivity by radio-frequency-free-carrier power absorption" Rev. Sci. Instrum. Vol. 47, No. 7, pp. 799, 1976 17

Split post dielectric resonator 5 GHz





Results of measurements for thin films

f (MHz)	Q	h(mm)	Rs (Ω)
5127.4	12558	blank substrate	
5127 .0	100	0	3.2705E+03
5127.0	1000	0	3.5251E+04
5127 .0	12200	0	1.3652E+07

Results of measurements for wafers

h(mm)	٤ _r	tanδ	ρ (Ωcm)	
.438	9.402	3.9494E-06	9.62E+06	Sapphire
1.500	4.422	3.1873E-05	2.54E+06	Quartz
.995	11.645	2.5582E-03	1.23E+04	Silicon

Single post dielectric resonators (SiPDR)

10 GHz









Measurement range

 10^{-1} < Rs < $10^4 \Omega$

Inverted single post dielectric resonators

13.5 GHz





5 GHz





Resonance frequency shifts and Q-factors due to losses in semiconductor wafers for 5 GHz SiPDR





Differences in sensitivity of measurements between SPDR and SiPDR



Axial distribution of electric field energy in SPDR

Axial distribution of electric field energy in SiPDR

Resistivity mapping of HR semiconductors and high sheet resistance films employing SPDR (5 GHz)



Resistivity map on HR Si sample 6" (TOPSIL). Resistivity scale in Ω m



IMS2012 in Montréal





Cheaper alternative





Photograph of 5 GHz resistivity meter







J.Krupka, Danh Nguyen, and J. Mazierska, "Microwave and RF Methods of Contact less Mapping of the Sheet Resistance and the Complex Permittivity of Conductive Materials and Semiconductors", **Measurements Science and Technology**, vol.22, 085703 (6pp), 2011

Eddy current, SPDR and SiPDR methods

Parameter	Eddy current method	SPDR	SiPDR
Min. area/ thickness	14mm/0.9mm	20mm/1mm 10mm/0.5mm	20mm/1.2mm 8mm/0.5mm
Measurement range Rs (Ω)	0.1 Ω–10 kΩ	$4 \text{ k}\Omega - 10 \text{ M}\Omega$	$0.1 \Omega - 10 k\Omega$
Measurement range $\rho(\Omega cm)$	$5x10^{-3} - 10^3 \Omega cm$	200-10 ⁵ Ωcm	10 ⁻⁵ - 10 ³ Ωcm
Calibration standards	Necessary	Not necessary	Not necessary
Additional equipment	Not necessary	Necessary (ANA or Q-meter)	Necessary (ANA or Q-meter)
Substrates (for films)	Semi-insulating	Semi-insulating	Semi-insulating or arbitrary for h>3δ

Summary of contactless methods



Electromagnetic field interaction with not continuous conducting layers placed in SPDR

Pd

0.2 Ω



EM power dissipated





Magnetic field distribution around metal islands 0.2Ω



Electric field distribution

Conductivity and sheet impedance above and below percolation threshold



Effective conductivity of thin polyaniline films

M Popis, J. Krupka, I. Wielgus, and M. Zagórska, **Ferroelectrics**, Vol. 388, Pages: 5-9, 2009



Number of Institutions from particular countries that purchased resonators manufactured by QWED

